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FQP3N80C / FQPF3N80C N-Channel QFET[®] MOSFET 800 V, 3.0 A, 4.8 Ω

Features

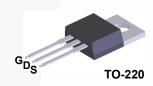
- 3.0 A, 800 V, ${\rm R}_{\rm DS(on)}$ = 4.8 Ω (Max.) @ V_{\rm GS} = 10 V, ${\rm I}_{\rm D}$ = 1.5 A
- Low Gate Charge (Typ. 13 nC)
- Low Crss (Typ. 5.5 pF)
- 100% Avalanche Tested

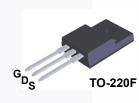
June 2014

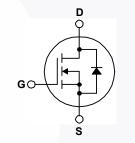
FQP3N80C / FQPF3N80C — N-Channel QFET[®] MOSFET

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.







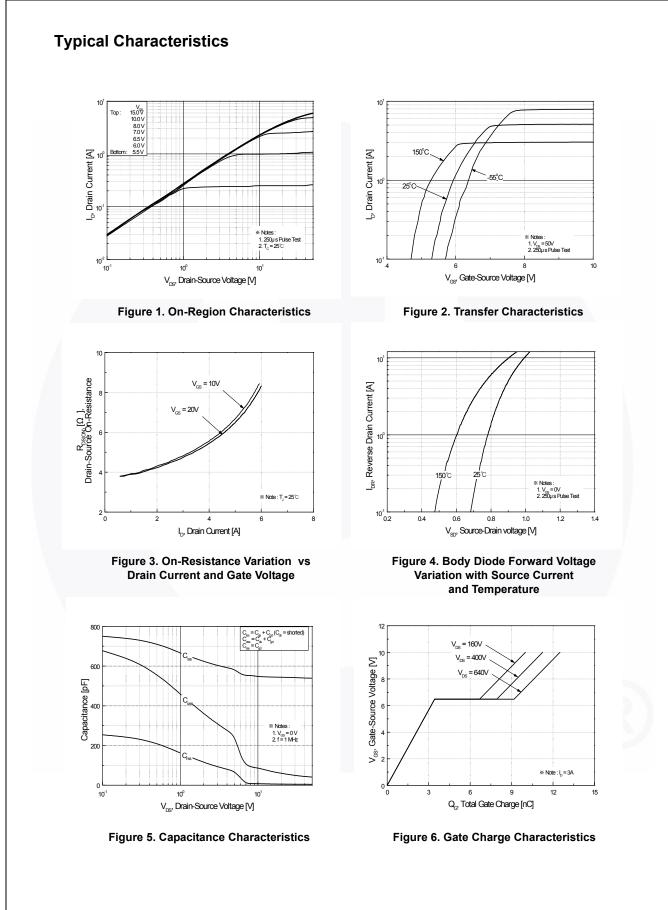
MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

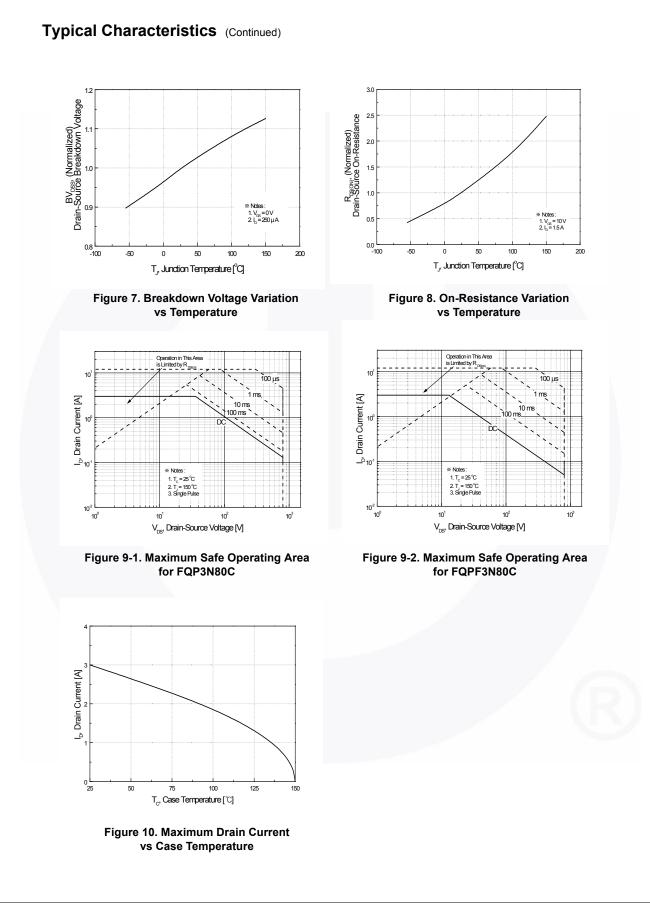
Symbol	Parameter Drain to Source Voltage			FQP3N80C	FQPF3N80C	Unit	
V _{DSS}				800		V	
I _D	Duain Current	-Continuous (T _C = 25 ^o C)	-Continuous ($T_c = 25^{\circ}C$) -Continuous ($T_c = 100^{\circ}C$)		3 *	А	
	Drain Current	-Continuous (T _C = 100 ^o C)			1.9 *	Α	
I _{DM}	Drain Current	- Pulsed	(Note 1)	12	12 *	Α	
V _{GSS}	Gate to Source Voltage			± 30		V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	320		mJ	
I _{AR}	Avalanche Current		(Note 1)	3		А	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	10.7		mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5		V/ns	
P _D	Dower Dissinction	(T _C = 25°C)		107	39	W	
	Power Dissipation	- Derate above 25°C		0.85	0.31	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300		°C	

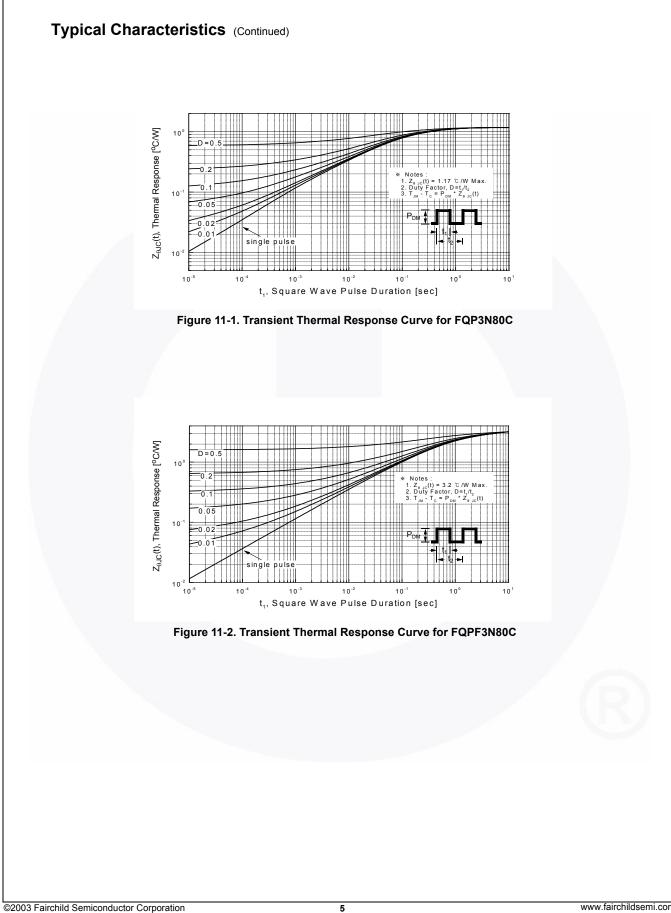
Thermal Characteristics

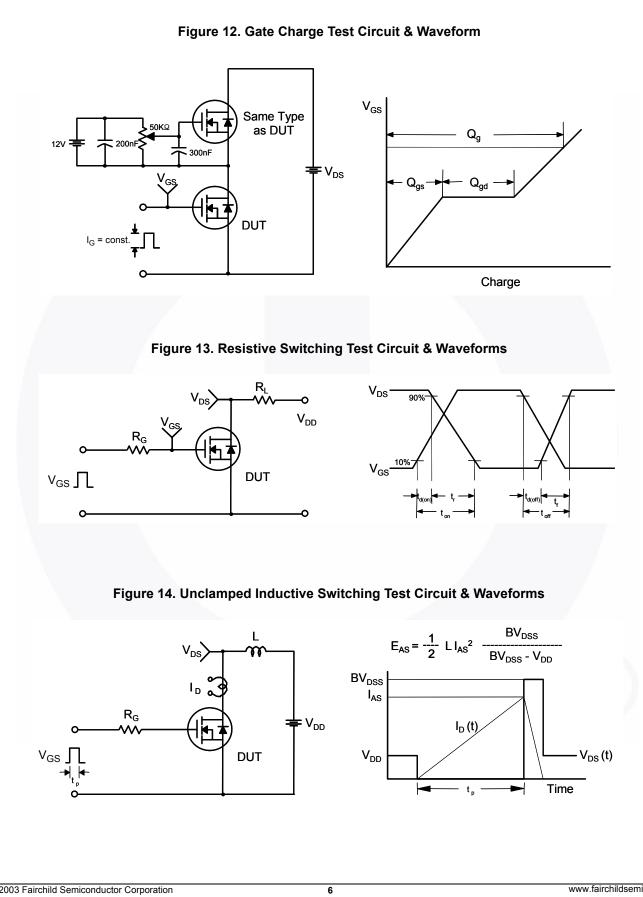
Symbol	Parameter	FQP3N80C	FQPF3N80C	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max	1.17	3.2	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max	62.5	62.5	°C/W

FQP3N80C FQP3N		Top Mark	Package	Packing Method	Reel Size	Tape Width	Qu	antity	
		FQP3N80C	TO-220	Tube	Tube	N/A	50	50 units 50 units	
		FQPF3N80C	TO-220F	Tube	Tube	N/A	50		
lectri	cal Char	acteristics T _C = 2	5ºC unless o	otherwise noted.					
Symbol		Parameter		Test Conditions	Min	Тур	Мах	Unit	
Off Cha	aracteristi	cs							
BV _{DSS}	Drain-Source Breakdown Voltage		V _{GS}	V _{GS} = 0 V, I _D = 250 μA				V	
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		oeffi- I _D =	$I_D = 250 \ \mu$ A, Referenced to 25°C		1		V/°C	
	Zero Gate Voltage Drain Current		V _{DS}	s = 800 V, V _{GS} = 0 V			10	μA	
DSS				$V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$			100	μA	
GSSF	Gate-Body	Gate-Body Leakage Current, Forward		s = 30 V, V _{DS} = 0 V			100	nA	
GSSR	Gate-Body	Leakage Current, Rever	rse V _{GS}	_s = -30 V, V _{DS} = 0 V			-100	nA	
On Cha	racteristic	cs							
V _{GS(th)}		Gate Threshold Voltage		V _{DS} = V _{GS} , I _D = 250 μA			5.0	V	
R _{DS(on)}		Static Drain-Source Dn-Resistance		_s = 10 V, I _D = 1.5 A		4.0	4.8	Ω	
9FS	Forward Tra	ansconductance	V _{DS}	s = 50 V, I _D = 1.5 A		3		S	
Dynam	ic Charact	teristics							
C _{iss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance		VDS	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz		543	705	pF	
C _{oss}						54	70	pF	
C _{rss}						5.5	7.5	pF	
Switchi	ing Charao	cteristics							
d(on)	Turn-On Delay Time		V	V_{DD} = 400 V, I _D = 3 A, R _G = 25 Ω		15	40	ns	
r	Turn-On Rise Time					43.5	95	ns	
d(off)	Turn-Off De	elay Time		2012		22.5	55	ns	
f	Turn-Off Fa	II Time			(Note 4)	32	75	ns	
Qg	Total Gate	Charge	V _{DS}	$V_{DS} = 640 \text{ V, } I_D = 3 \text{ A,}$ $V_{GS} = 10 \text{ V} $ (Note 4)		13	16.5	nC	
Q _{gs}	Gate-Sourc	e Charge	V _{GS}			3.4		nC	
Q _{gd}	Gate-Drain	Charge				5.8		nC	
Drain-S	ource Dio	de Characteristics	s and Ma	ximum Ratings					
S	Maximum Continuous Drain-Source Diode						3.0	A	
SM	Maximum Pulsed Drain-Source Diode For						12	A	
√ _{SD}	Drain-Source Diode Forward Voltage			V _{GS} = 0 V, I _S = 3.0 A			1.4	V	
rr		verse Recovery Time		$V_{GS} = 0 V, I_S = 3.0 A,$ $dI_F / dt = 100 A/\mu s$		642		ns	
Q _{rr}	Reverse Recovery Charge		dl _F /			4.0		μC	
otes:									









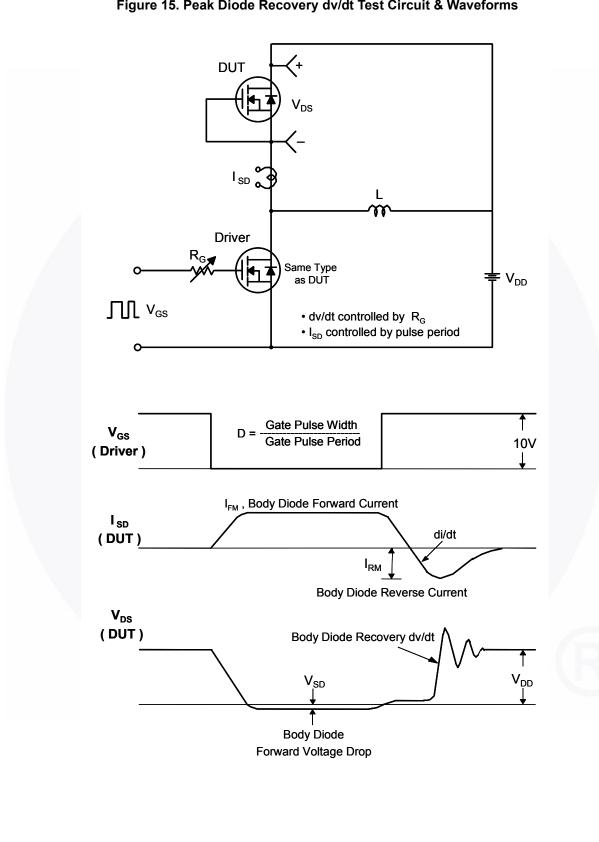
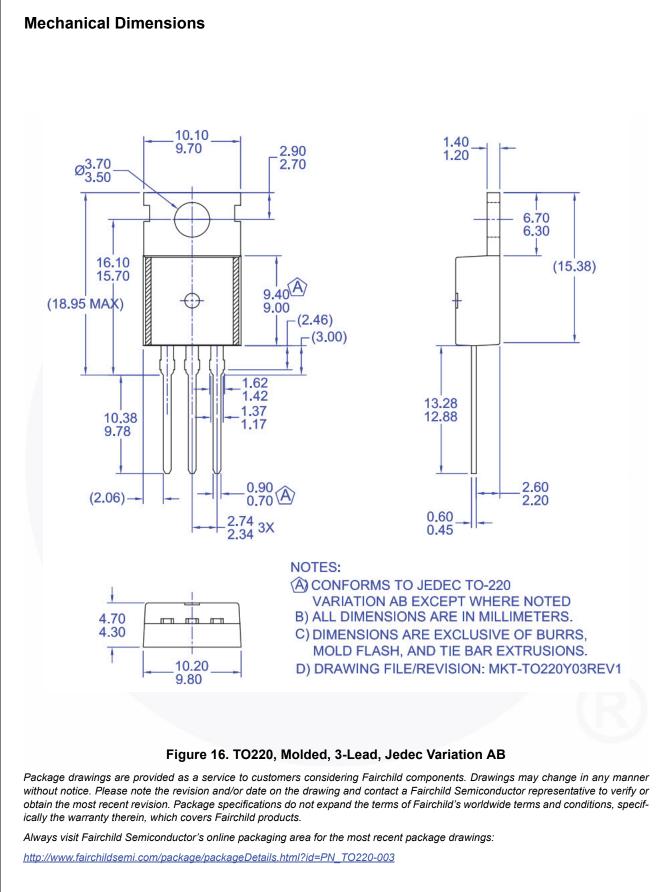
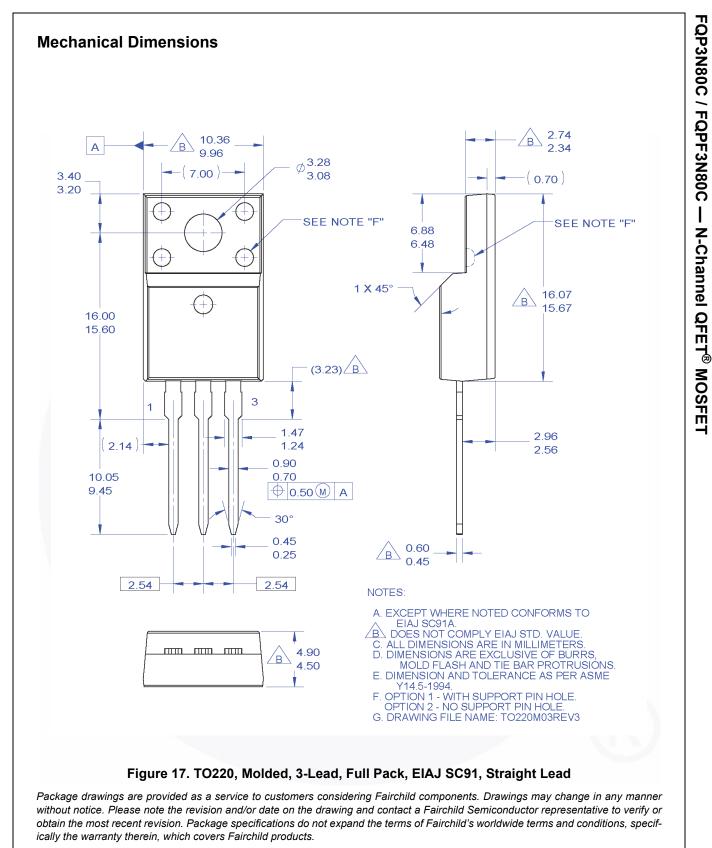


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



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http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TF220-003



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